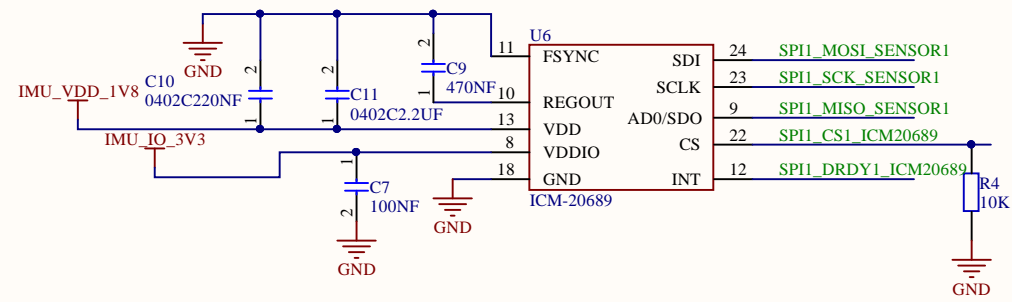
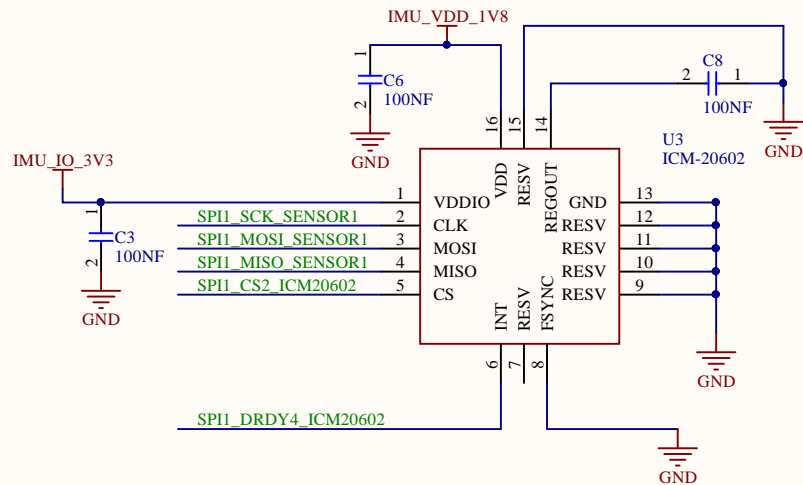
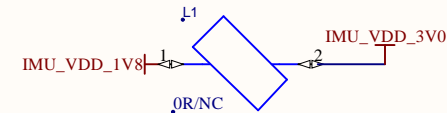
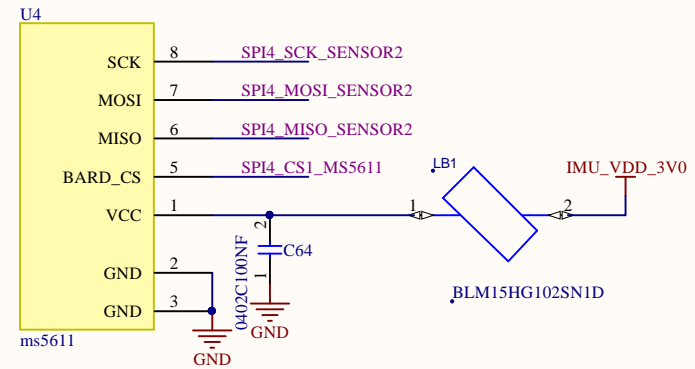
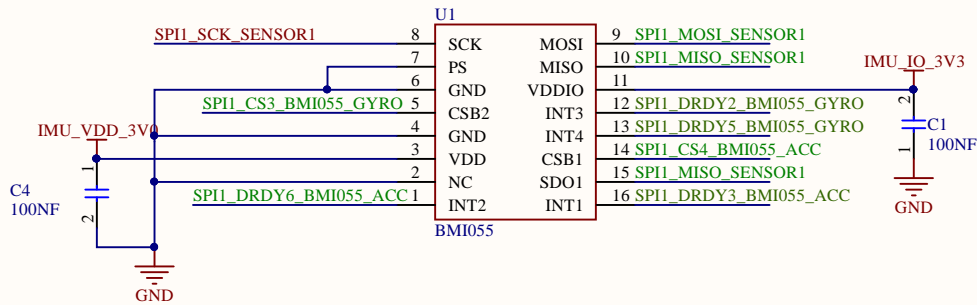


Note:SPI6 has no sensor connection  
HEATER function is not used

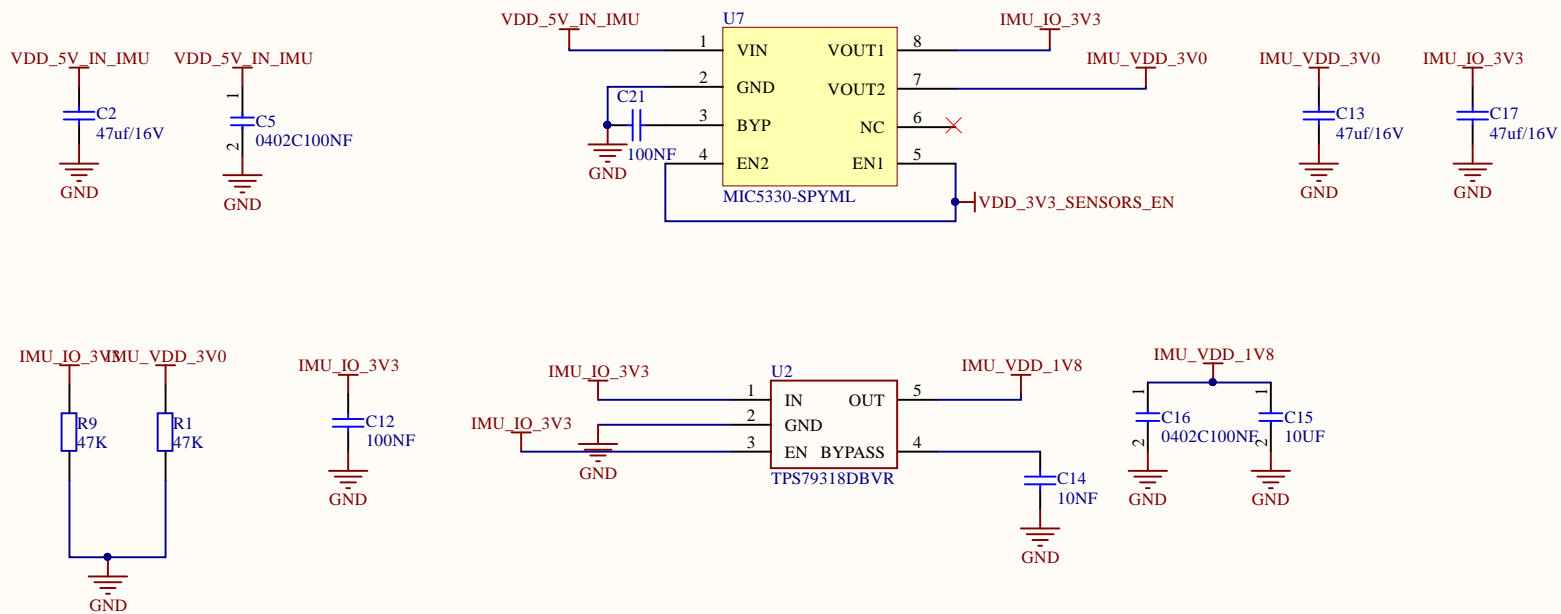
V5+ IMU  
CUAV

M1 M2 M3 M4  
MARK MARK MARK MARK

Tiele: V5+_IMU		SHEET 01 OF 03
VER	RC03	DATE: 2019-1-20
Designer	bin	
Reviewed		



Tiele: V5+_IMU		SHEET 02 OF 03	
VER	RC03	DATE: 2019-5-4	
Designer	bin		
Reviewed			



Tiele: V5+_IMU		SHEET 03 OF 03
VER	RC03	DATE: 2019-5-2
Designer	bin	
Reviewed		

1

2

3

4

A

A

Modify list

V5\_IMU\_RC02

修改为软硬一体结合主板设计

修改电源部分

2019-5-19 修改定义，与CORE一致

B

B

C

C

D

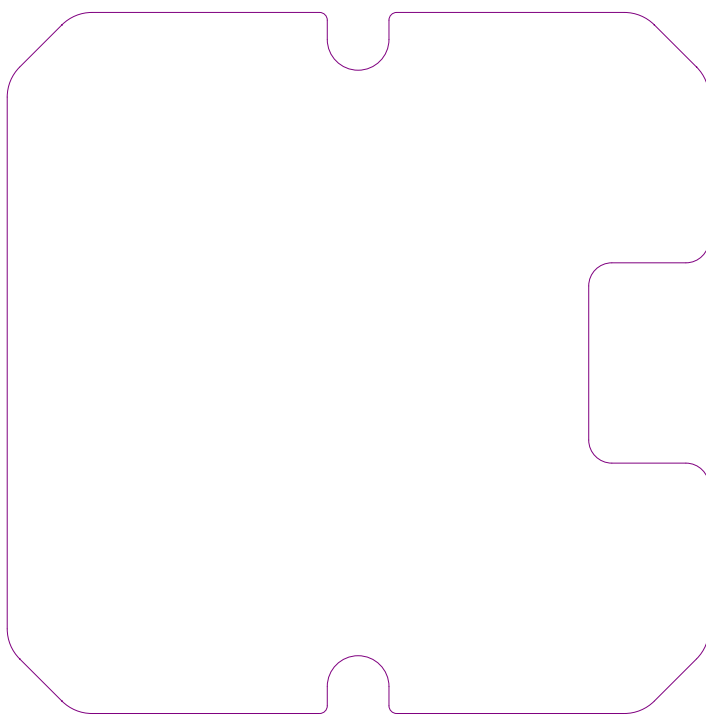
D

1

2

3

4



绿色哑光油墨  
1.0mm总体厚度  
FPC黄色覆盖膜 0.1mm厚度  
沉金工艺2U  
过孔塞孔

